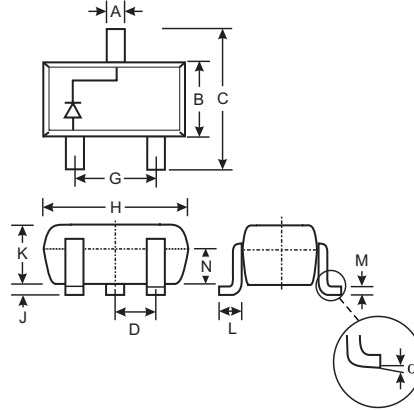


### Features

- Ultra-Small Surface Mount Package
- Fast Switching Speed
- For General Purpose Switching Applications
- High Conductance
- Available in Lead Free/RoHS Compliant Version (Note 3)

### Mechanical Data

- Case: SOT-523
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Also Available in Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Please See Ordering Information, Note 5, on Page 2
- Polarity: See Diagram
- Marking: T3 (See Page 2)
- Weight: 0.002 grams (approx.)



SOT-523			
Dim	Min	Max	Typ
A	0.15	0.30	0.22
B	0.75	0.85	0.80
C	1.45	1.75	1.60
D	—	—	0.50
G	0.90	1.10	1.00
H	1.50	1.70	1.60
J	0.00	0.10	0.05
K	0.60	0.80	0.75
L	0.10	0.30	0.22
M	0.10	0.20	0.12
N	0.45	0.65	0.50
$\alpha$	0°	8°	—
All Dimensions in mm			

### Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	250	V
Working Peak Reverse Voltage DC Blocking Voltage	$V_{RWM}$ $V_R$	200	V
RMS Reverse Voltage	$V_{R(RMS)}$	141	V
Forward Continuous Current (Note 1)	$I_{FM}$	400	mA
Average Rectified Output Current (Note 1)	$I_O$	200	mA
Non-Repetitive Peak Forward Surge Current @ $t = 1.0\mu\text{s}$ @ $t = 1.0\text{s}$	$I_{FSM}$	2.5 0.5	A
Repetitive Peak Forward Surge Current	$I_{FRM}$	625	mA
Power Dissipation (Note 1)	$P_d$	150	mW
Thermal Resistance Junction to Ambient (Note 1)	$R_{\theta JA}$	833	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_j, T_{STG}$	-65 to +150	$^\circ\text{C}$

### Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	250	—	V	$I_R = 100\mu\text{A}$
Forward Voltage (Note 2)	$V_F$	—	1.0 1.25	V	$I_F = 100\text{mA}$ $I_F = 200\text{mA}$
Reverse Current @ Rated DC Blocking Voltage (Note 2)	$I_R$	—	100 15	nA $\mu\text{A}$	$T_j = 25^\circ\text{C}$ $T_j = 100^\circ\text{C}$
Total Capacitance	$C_T$	—	5.0	pF	$V_R = 0, f = 1.0\text{MHz}$
Reverse Recovery Time	$t_{rr}$	—	50	ns	$I_F = I_R = 30\text{mA}$ , $I_{rr} = 0.1 \times I_R, R_L = 100\Omega$

- Notes:
1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
  2. Short duration test pulse used to minimize self-heating effect.
  3. No purposefully added lead.

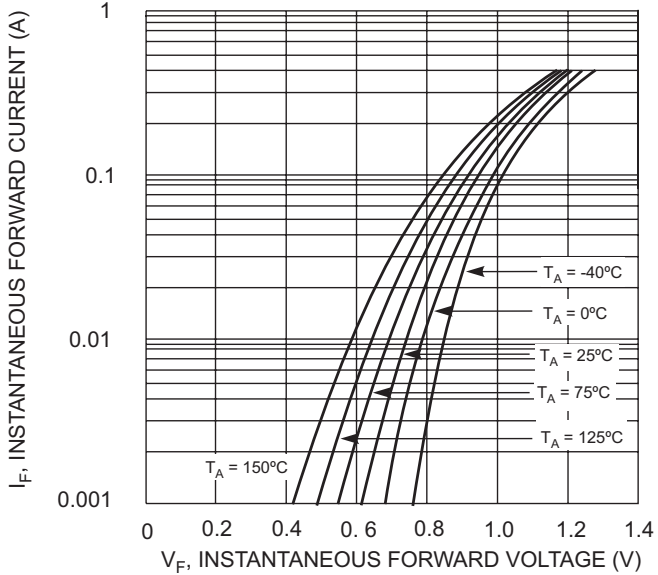


Fig. 1 Typical Forward Characteristics

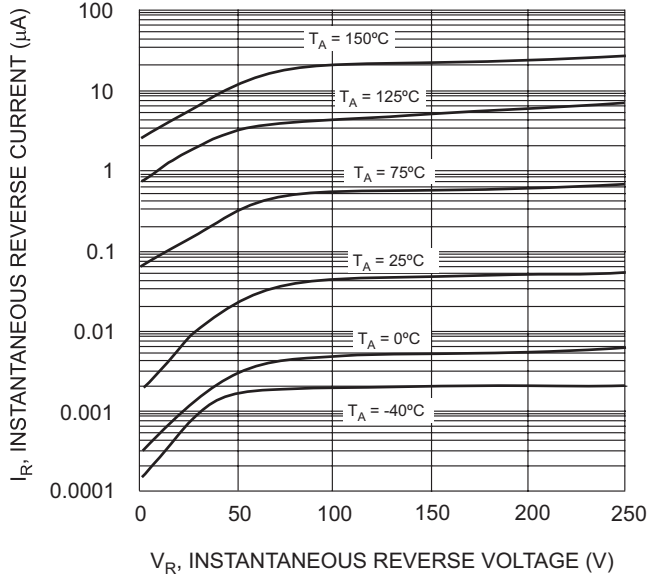


Fig. 2 Typical Reverse Characteristics

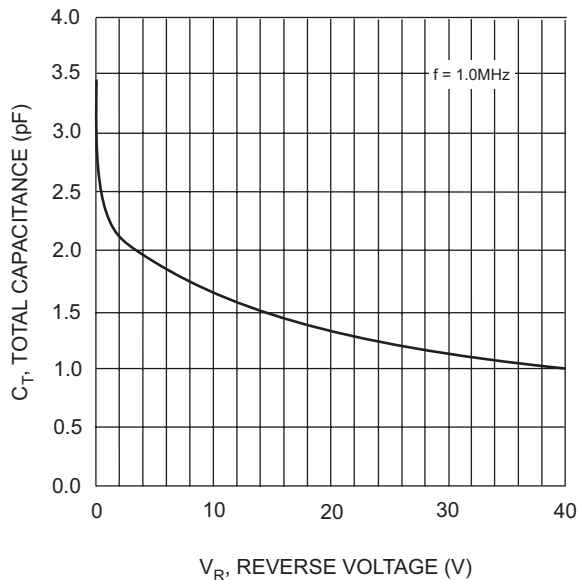


Fig. 3 Typical Capacitance vs. Reverse Voltage

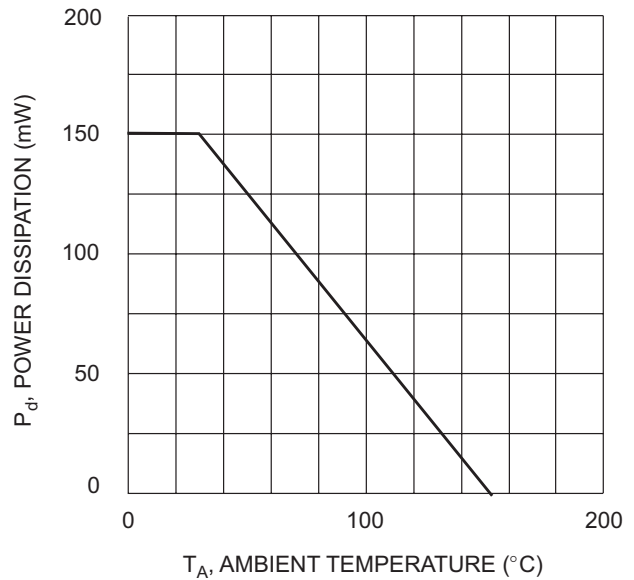


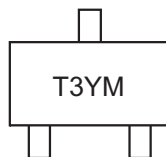
Fig. 4 Power Derating Curve, Total Package

**Ordering Information** (Note 4)

Device	Packaging	Shipping
BAS21T-7	SOT-523	3000/Tape & Reel

- Notes: 4. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.  
5. For Lead Free/RoHS Compliant version part number, please add "-F" suffix to the part number above. Example: BAS21T-7-F.

**Marking Information**



T3 = Product Type Marking Code  
Y M = Date Code Marking  
Y = Year (ex: N = 2002)  
M = Month (ex: 9 = September)

Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009
Code	M	N	P	R	S	T	U	V	W

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D